**Preferred Devices** 

# **NPN Silicon Power Transistors High Voltage Planar**

The MJW18020 planar High Voltage Power Transistor is specifically Designed for motor control applications, high power supplies and UPS's for which the high reproducibility of DC and Switching parameters minimizes the dead time in bridge configurations.

### **Features**

- High and Excellent Gain Linearity
- Fast and Very Tight Switching Times Parameters tsi and tfi
- Very Stable Leakage Current due to the Planar Structure
- High Reliability
- Pb-Free Package is Available\*

### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector–Emitter Sustaining Voltage	V <sub>CEO</sub>	450	Vdc
Collector-Base Breakdown Voltage	V <sub>CES</sub>	1000	Vdc
Collector-Base Voltage	V <sub>CBO</sub>	1000	Vdc
Emitter-Base Voltage	V <sub>EBO</sub>	9.0	Vdc
Collector Current – Continuous – Peak (Note 1)	I <sub>C</sub>	30 45	Adc
Base Current – Continuous – Peak (Note 1)	I <sub>B</sub>	6.0 10	Adc
Total Power Dissipation @ T <sub>C</sub> = 25°C Derate Above 25°C	P <sub>D</sub>	250 2.0	W W/°C
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +150	°C

### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	0.5	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	50	°C/W
Maximum Lead Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds	T <sub>L</sub>	275	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

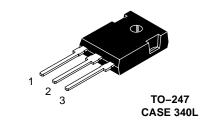
1. Pulse Test: Pulse Width = 5  $\mu$ s, Duty Cycle  $\leq$  10%.



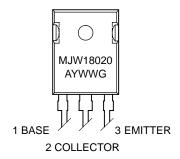
### ON Semiconductor®

http://onsemi.com

## 30 AMPERES 1000 VOLTS BV<sub>CES</sub> 450 VOLTS BV<sub>CEO.</sub> 250 WATTS



### MARKING DIAGRAM



= Assembly Location

= Year = Work Week

= Pb-Free Package

### ORDERING INFORMATION

Device	Package	Shipping
MJW18020	TO-247	30 Units/Rail
MJW18020G	TO-247 (Pb-Free)	30 Units/Rail

Preferred devices are recommended choices for future use and best overall value.

<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

## **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = 25°C unless otherwise noted)

Characte	Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTICS						
Collector–Emitter Sustaining Voltage $(I_C = 100 \text{ mAdc}, I_B = 0)$		$V_{\text{CEO(sus)}}$	450	-	_	Vdc
Collector Cutoff Current ( $V_{CE} = Rated V_{CEO}$ , $I_B = 0$ )		I <sub>CEO</sub>	_	-	100	μAdc
Collector Cutoff Current (V <sub>CE</sub> = Rated V <sub>C</sub> (T <sub>C</sub> = 125°C)	$_{\text{CES}}$ , $V_{\text{EB}} = 0$ )	I <sub>CES</sub>	-	-	100 500	μAdc
Emitter Cutoff Current (V <sub>CE</sub> = 9 Vdc, I <sub>C</sub> = 0)	I <sub>EBO</sub>	_	-	100	μAdc	
ON CHARACTERISTICS				I.		
DC Current Gain $(I_C = 3 \text{ Adc}, V_{CE} = 5 \text{ Adc})$ $(I_C = 10 \text{ Adc})$ $V_{CE} = 2 \text{ Adc}$ $V_{CE} = 2 \text{ Adc}$	$(T_C = 125^{\circ}C)$ $(T_C = 125^{\circ}C)$ $(T_C = 125^{\circ}C)$ $(T_C = 125^{\circ}C)$	h <sub>FE</sub>	14 - 8 5 5.5 4	30 16 14 9 7	34 - - - -	
(I <sub>C</sub> = 10 mAdc V <sub>CE</sub> =	= 5 Vdc)		14	25	-	
Base–Emitter Saturation Voltage ( $I_C = 10$ ) ( $I_C = 20$ )	O Adc, I <sub>B</sub> = 2 Adc) O Adc, I <sub>B</sub> = 4 Adc)	V <sub>BE(sat)</sub>	_	0.97 1.15	1.25 1.5	Vdc
Collector–Emitter Saturation Voltage ( $I_C = 10 \text{ Adc}$ , $I_B = 2 \text{ Adc}$ ) ( $I_C = 20 \text{ Adc}$ , $I_B = 4 \text{ Adc}$ )  DYNAMIC CHARACTERISTICS	(T <sub>C</sub> = 125°C) (T <sub>C</sub> = 125°C)	V <sub>CE(sat)</sub>	- - - -	0.2 0.3 0.5 0.9	0.6 - 1.5 2.0	Vdc
Current Gain Bandwidth Product		f <sub>T</sub>	I _	13	_	MHz
$(I_C = 1 \text{ Adc}, V_{CE} = 10 \text{ Vdc}, f_{test} = 1 \text{ MHz})$		•1		.0		1411.12
Output Capacitance (V <sub>CB</sub> = 10 Vdc, I <sub>E</sub> = 0, f <sub>test</sub> = 1 MHz)		C <sub>ob</sub>	_	300	500	pF
Input Capacitance (V <sub>EB</sub> = 8.0)	C <sub>ib</sub>	_	7000	9000	pF	
SWITCHING CHARACTERISTICS: Res	stive Load (D.C. = 10%, Pulse Width	= 70 μs)	1		<u>I</u>	
Turn-On Time	(I <sub>C</sub> = 10 Adc, I <sub>B1</sub> = I <sub>B2</sub> = 2 Adc, Vcc = 125 V)	t <sub>On</sub>	_	540	750	ns
Storage Time		ts	_	4.75	6	μs
Fall Time		t <sub>f</sub>	_	380	500	ns
Turn-Off Time	]	t <sub>Off</sub>	-	5.2	6.5	μs
Turn-On Time	$(I_C = 20 \text{ Adc}, I_{B1} = I_{B2} = 4 \text{ Adc},$	t <sub>On</sub>	-	965	1200	ns
Storage Time	Vcc = 125 V)	ts	-	2.9	3.5	μs
Fall Time	all Time		-	350	500	ns
Turn-Off Time	t <sub>Off</sub>	-	3.25	4	μs	
SWITCHING CHARACTERISTICS: Indu	ctive Load (V <sub>clamp</sub> = 300 V , Vcc = 15	5 V, L = 200 μH)			-	
Fall Time	$(I_C = 10 \text{ Adc}, I_{B1} = I_{B2} = 2 \text{ Adc})$	t <sub>fi</sub>	-	142	250	ns
Storage Time	]	t <sub>si</sub>	-	4.75	6	μs
Crossover Time		t <sub>C</sub>	-	320	500	ns
Fall Time	$(I_C = 20 \text{ Adc}, I_{B1} = I_{B2} = 4 \text{ Adc})$	t <sub>fi</sub>	-	350	500	ns
Storage Time	ge Time		_	3.0	3.5	μS
Storage Time		t <sub>si</sub>				

### **TYPICAL CHARACTERISTICS**

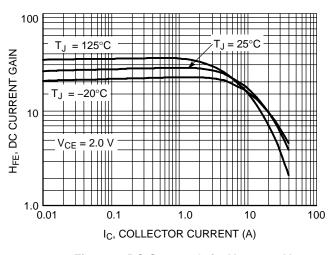


Figure 1. DC Current Gain, V<sub>CE</sub> = 2.0 V

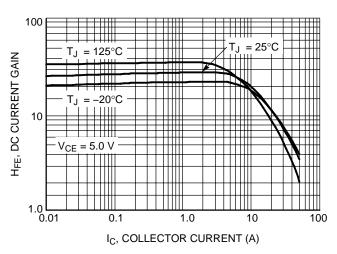


Figure 2. DC Current Gain, V<sub>CE</sub> = 5.0 V

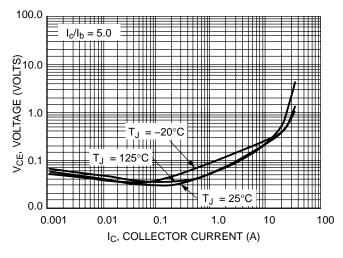


Figure 3. Typical Collector–Emitter Saturation Voltage,  $I_C/I_B = 5.0$ 

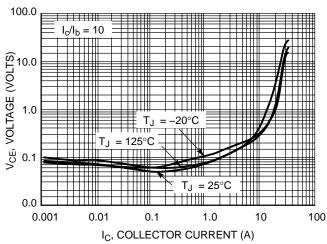


Figure 4. Typical Collector–Emitter Saturation Voltage,  $I_C/I_B = 10$ 

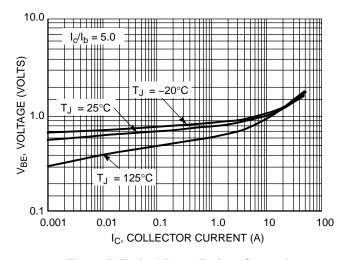


Figure 5. Typical Base–Emitter Saturation Voltage,  $I_C/I_B = 5.0$ 

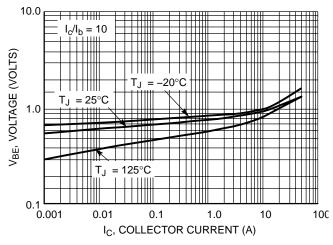


Figure 6. Typical Base–Emitter Saturation Voltage, I<sub>C</sub>/I<sub>B</sub> = 10

## **TYPICAL CHARACTERISTICS**

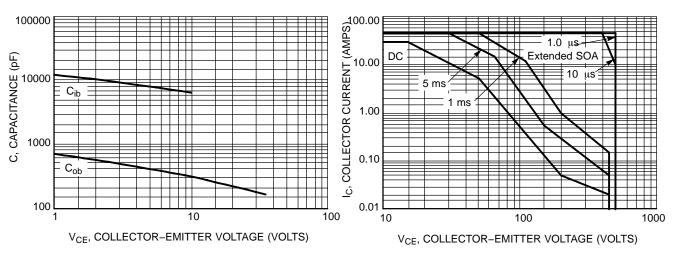


Figure 7. Typical Capacitance

Figure 8. Forward Bias Safe Operating Area

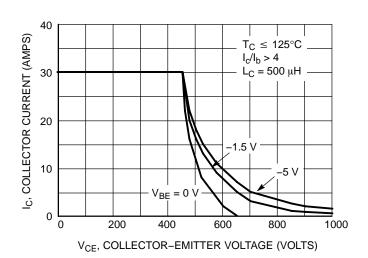
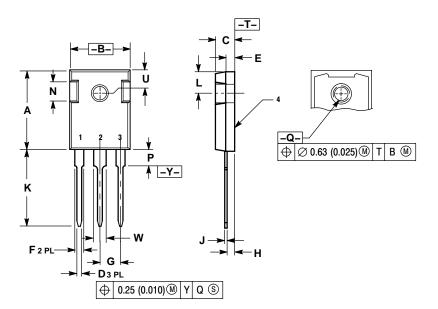


Figure 9. Reverse Bias Safe Operating Area

### PACKAGE DIMENSIONS

TO-247 PSI CASE 340L-02 ISSUE D



#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982. 2. CONTROLLING DIMENSION: MILLIMETER.

	MILLIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	20.32	21.08	0.800	8.30	
В	15.75	16.26	0.620	0.640	
С	4.70	5.30	0.185	0.209	
D	1.00	1.40	0.040	0.055	
Е	2.20	2.60	0.087	0.102	
F	1.65	2.13	0.065	0.084	
G	5.45 BSC		0.215 BSC		
Н	1.50	2.49	0.059	0.098	
J	0.40	0.80	0.016	0.031	
K	20.06	20.83	0.790	0.820	
L	5.40	6.20	0.212	0.244	
N	4.32	5.49	0.170	0.216	
Р		4.50		0.177	
Q	3.55	3.65	0.140	0.144	
U	6.15 BSC		0.242 BSC		
W	2.87	3.12	0.113	0.123	

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